504397349 06/05/2017

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4444046

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TADASHI MATSUSHITA	05/13/2016
WOLFGANG VOEGELI	05/20/2016
TETSURO SHIRASAWA	05/31/2016
TOSHIO TAKAHASHI	05/13/2016
ETSUO ARAKAWA	05/20/2016

RECEIVING PARTY DATA

Name:	INTER-UNIVERSITY RESEARCH INSTITUTE CORPORATION HIGH ENERGY ACCELERATOR RESEARCH ORGANIZATION		
Street Address:	ess: 1-1 OHIO, TSUKUBA-SHI		
City:	IBARAKI		
State/Country:	JAPAN		
Postal Code: 305-0801			

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14651813	

CORRESPONDENCE DATA

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		e-mail address first; if that is unsuccessful, it will be sent nat is unsuccessful, it will be sent via US Mail.				
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ATTORNEY DOCKET NUMBER:		1792-0001WOUS				
NAME OF SUBMITTER:		ROBERT L. RISPOLI				
SIGNATURE:		/Robert L. Rispoli/				
DATE SIGNED:		06/05/2017				

Total Attachments: 6

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ASSIGNMENT

WHEREAS, we, as below named inventors, residing at the addresses stated below our names, are joint inventors of certain new and useful improvements in METHOD AND APPARATUS FOR MEASURING SCATTERING INTENSITY DISTRIBUTION, for which a non-provisional application was filed in the U.S. Patent and Trademark Office on June 12, 2015 and has been assigned Application No. 14/651,813, which is a national stage application of and claims priority to PCT Application No. PCT/JP2013/083064, filed December 10, 2013, and claims priority to Japanese Patent Application No. JP 2012-273064 filed on December 14, 2012.

WHEREAS, we possess the entire right, title and interest in the foregoing invention, free from all encumbrances, and has full right to convey his part or all of his interest, and

WHEREAS, Inter-University Research Institute Corporation High Energy Accelerator Research Organization (hereinafter referenced as ASSIGNEE), a Japanese corporation having a place of business at 1-1 Oho, Tsukuba-shi, Ibaraki 305-0801 Japan, is desirous of acquiring all rights, title and interest in, to and under said inventions, said applications disclosing the inventions and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, we, as joint inventors as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the full, exclusive and entire right, title and interest in the said inventions, said applications, and any divisions, continuations and reissues thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and the right to sue and collect damages for past infringement, and to any other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and we hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

AND we further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to us and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

PATENT REEL: 042594 FRAME: 0738

Date

Date

Date

AND we further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reexaminations, reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

AND we further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to us and will testify as to the same in any reexamination, interference or litigation related thereto;

AND we hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

May 13, 2016. Todashi materiahita

Tadzshi Matsushita. o/o Inter-University Research Institute Corp, 1-1 Oho, Tsukuba-shi Ibaraki 305-0801 JP

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Wolfgang Voegeli c/o Inter-University Research Institute Corp, 1-1 Oho, Tsukuba-shi Ibaraki 305-0801 JP

Witness

Witness

Tetsuro Shirasawa 6-3-7 Kashiwanoha, Kashiwa-shi Chiba 277-0882 JP

Witness

2 of 3

PATENT REEL: 042594 FRAME: 0739

AND we further agree to properly execute and deliver and without further remoneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reexaminations, reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

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Tadashi Matsushita. c/o Inter-University Research Institute Corp, 1-1 Oho, Tsukuba-shi Ibaraki 305-0801 JP

Wolfgang Võegeli c/o Inter-University Research Institute Corp, 1-1 Oho, Tsukuba-shi Ibaraki 305-0801 JP <u>May/20/2016</u> Date

Date

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Tetsuro Shirasawa 6-3-7 Kashiwanoha, Kashiwa-shi Chiba 277-0882 JP

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Witness	Tadashi Matsushita. c/o Inter-University Research Institute Corp, 1-1 Oho, Tsukuba-shi Ibaraki 305-0801 JP	Date	
Witness	· · · · · · · · · · · · · · · · · · ·		
Witness	Wolfgang Voegeli c/o Inter-University Research Institute Corp, 1-1 Oho, Tsukuba-shi Ibaraki 305-0801 JP	Date	
Witness			;
	白潭做部	5/31/2016	3
Witness	Tetsuro Shirasawa 6-3-7 Kashiwanoha, Kashiwa-shi Chiba 277-0882 JP	Date	
Witness	2 of 3		
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J. Ja Sahashi

May /13/2016 Date

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Toshio Takahashi 6-1-11 Otsuka, Bunkyo-ku Tokyo 112-0012 JP

Witness

Etsuo Arakawa 1-2-39 Fujimi-Cho, Higashimurayama-shi Tokyo 189-0024 JP

Date

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3 of 3

PATENT REEL: 042594 FRAME: 0742

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Witness

Toshio Takahashi 6-1-11 Otsuka, Bunkyo-ku Tokyo 112-0012 JP

烹い悦雄

Etsuo Arakawa 1-2-39 Fujimi-Cho, Higashimurayama-shi Tokyo 189-0024 JP Date

20 2016 Date

PATENT REEL: 042594 FRAME: 0743

RECORDED: 06/05/2017

3 of 3